

DIGITAL CLOCK DISTRIBUTOR

DCD-400, DCD-ST2, AND DCD-CIM

GENERAL DESCRIPTION AND SPECIFICATIONS

1. GENERAL 1 A. Card Quantities (Maximum) 2. INTRODUCTION 2 C. System Specifications	
	ut Kits 11
D. Card Specifications	16
3. DESCRIPTION	
A. Master Shelf	
C. DCD-ST2 and DCD-400	
D. DCD-CIM	tions, specifica-
E. System Expansion 5 tions, and typical applications for the	
F. Output Panels	
G. System Power 12	
H. System Diagnostics and Protection 1.02 This practice has been reissue	
Switching	•
4. APPLICATIONS	DCD-ST2 and
A. DCD Applications	
B. SCIU Applications	
5. SPECIFICATIONS	d as "CIM". Ūn-
figures formation is common to all systems.	,
1. DCD-ST2 Master Shelf	System (SMS)
2. DCD-400 Master Shelf 8 may be installed in the DCD System	ns to implement
3. DCD-CIM Master Shelf 8 DS1 performance monitoring. For d	
4. DCD System Configuration 9 the installation and operation of the	
5. Wire-wrap Output Panels 10 cluding the Communications Unit (
6. Modular Mounting Panel	
7. Modular Mounting Panel Output Kits 11 TMSL 097-40000-11, and TMSL 097-	40000-12.
8. Typical DCD Applications 14	0 (3.53)
9. SCIU Applications	

Page 1

interface. The MI card works in conjunction with an Alarm Interface Adapter (AIA) card to connect alarm inputs from the expansion shelves and clock status leads from the DCD shelf to the MI card. The AIA also provides an RS-232 communications port. Refer to TMSL 097-40000-26 for details regarding the installation and operation of the MI and AIA cards.

1.06 The optional SCIU Alarm and Monitoring (SAM) card provides a monitoring function to alert office personnel of removed SCIU cards that may affect customer service.

1.07 The following abbreviations are used in this document:

ACO Alarm cutoff ACI Analog Clock Input card ΑI Alarm Interface card AIS **Alarm Indication Signal** APS Automatic protection switching B8ZS Bipolar with 8 Zero Substitution BITS Building Integrated Timing Supply CCComposite Clock card CIClock Input card CIM Clock Insertion and Monitor System **CMU** Communications Unit COFA Change of Frame Alignment CPE **Customer Premises Equipment** D4DS1 Superframe format DCD Digital Clock Distributor DCS Digital Cross-connect System DDS Digital Data System DS1Digital Signal, level 1 (1.544 Mb/s) DSX-1 Digital Cross-connect level 1 **ESF** Extended Superframe format FAFuse and Alarm card FDM Frequency division multiplex HS Hot spare card LOS Loss of signal LPR-L3 Local Primary Reference-Loran 3 MCA Matrix Controller Automatic card MCA-2 Matrix Controller Automatic-2 card MIMaintenance Interface card MTIE Maximum Time Interval Error NE **Network Element** OOF Out of frame PBX Private Branch Exchange RTZReturn-to-zero

SCIU	Synchronous Clock Insertion Unit card
SMS	Synchronization Monitor System
SMU	Synchronization Monitor Unit
SONET	Synchronous Optical Network
ST2	Stratum-2 clock
ST2E	Enhanced Stratum-2 clock
ST3	Stratum-3 clock
ST3E	Enhanced Stratum-3 clock
TIE	Time Interval Error
TOxA	Timing Output card
TOAA	Timing Output Analog Automatic card
TOCA	Timing Output Composite Clock Auto-
	matic card
TOLA	Timing Output Logic Level Automatic
	card
TOTA	Timing Output DS1 Automatic card
TSG	Timing Signal Generator

INTRODUCTION

2.01 The Digital Clock Distributor (DCD) system provides a means of implementing the Building Integrated Timing Supply (BITS) concept within a buildcontaining telecommunications digital ing equipment connected to the telecommunications digital network. The BITS concept advocates the establishment of a single master timing supply per administrative building, which provides a common clock source for frequency and phase synchronization to network elements (NE) necessary for digital cross-connectivity and transport.

2.02 The BITS has the highest quality clock within a building. It is directly referenced from a Stratum-1 local primary reference (LPR) or an upstream Stratum-1 via the interoffice synchronization distribution network. The BITS distributes all timing (frequency and phase) required by other clocks within that building.

2.03 The stratum clock cards within the DCD master shelf provide long-term averaging of the input reference to the DCD. If the input is disrupted or is out of tolerance, the DCD clock cards provide the necessary bridge in timing (holdover) and allows the network to continue to operate slip-free for several hours or days depending on the stratum quality of the clock cards installed.

2.04 The DCD regenerates a clocking signal from its input reference and buffers the short term timing variations, and generates a variety of output signals required by the NEs, e.g., framed all-ones DS1, 64 kb/s composite clock (CC), various analog frequencies, and various RS-422/RS-423/RS-232 frequencies. NEs timed from the DCD system permits unrestricted DS0 cross-connection between NEs.

2.05 The output cards of the DCD system provide distribution of timing signals for channel banks, digital switches, digital loop carrier (DLC), digital cross-connect systems (DCS), SONET OC-n terminals, ISDN equipment, digital radio, FDM carrier, PBX systems and other devices that interconnect with the telecommunications digital network.

2.06 The DCD system when equipped with Stratum-2 clock cards can accept input references from Telecom Solutions DCD-LPR (Local Primary Reference) system equipped with a GPS (Global Positioning System) and/or LORAN-C receivers traceable to Universal Coordinated Time (UTC). The combination of the DCD and DCD-LPR provide a local Stratum-1 source.

3. DESCRIPTION

3.01 The DCD system consists of the DCD-ST2, DCD-400 and DCD-CIM shelves and various input, clock, output, output protection switching and alarms cards. The shelves may be installed as a master shelf or as expansion shelves. A full system of a master and three expansion shelves has either 34 (DCD-ST2 master) or 40 output card slots capable of up to 340 (DCD-ST2 master) or 400 timing output signals. The system is modular design and permits incremental growth of a shelf and/or an output card at a time.

A. Master Shelf

3.02 All DCD systems must have a master shelf equipped with an output panel. The master shelf accepts input references, contains the clock cards, and provides clocking to the expansion shelves. It also contains timing outputs, output protection switching, and alarm and maintenance interfaces.

3.03 If unprotected outputs are desired, or if the shelf is to be equipped with only synchronous clock insertion (SCIU) cards, then output protection cards (hot standby cards and MCA/MCA-2) should not be installed. All TOx (x = 1 to 10), HS TOC and HS TOT card slots can be cabled as unprotected output slots.

B. Input Reference Signals

3.04 Input signals are arranged in pairs and designated A (primary) and B (secondary). Input reference signals can be:

- DS1 from an upstream Stratum-1 reference or LPR-L3
- Composite clock (CC) from an existing office clock
- 16.384-MHz composite clock from a #4ESS digital switch
- 2.048 MHz from a DACS II

3.05 For ST2 or ST2E clocks, the incoming DS1 reference *must* be of Stratum-2 or better quality. For ST-3 or ST-3E clocks, the reference *must* be of Stratum-3 or better quality, as defined in ANSI-T1-101.

3.06 DS1 or CC input reference signals can be accepted by the CI card.

3.07 Input reference signals from the DSX-1 to the DCD can be terminated in 100 ohms (–20 dB signals) or bridged (0 dB signals) by the built-in bridging repeater in the CI card. This allows the system to be located up to 655 feet from the DSX-1. CC input reference signals to the DCD are terminated in 133 ohms.

C. DCD-ST2 and DCD-400

3.08 The ST2 operates at Stratum-2, Stratum-2E, Stratum-3, or Stratum-3E stability, and the 400 at Stratum-3 or Stratum-3E stability. In freerun or holdover modes, either unit can act as the office clock in a BITS environment or as a free-running clock source.

3.09 Up to three expansion shelves can be installed in the ST2 or 400; the 400 can be used as an expansion shelf for the 400 and the ST2 master shelves; the ST2 cannot be used as an expansion shelf.

System Components

- **3.10** The ST2 and 400 Systems consist of a master shelf with any combination of the following cards:
 - AI card for the ST2, or FA card for the 400
 - Two CI or ACI cards
 - Two stratum clock cards (ST2E, ST2, ST3E, or ST3 for the DCD-ST2; ST3E or ST3 for the DCD-400).
 - Output cards, including:
 - Timing Output cards (TOAA, TOCA TOLA, TOTA)
 - Synchronous Clock Insertion card (SCIU)
 - Synchronization Monitor card (SMU)

Output Protection cards:

- Hot Standby cards (TOAA, TOCA, TOLA, TOTA)
- Matrix Controller card (MCA, MCA-2)

Timing Output Signals

3.11 The number and types of timing output signals are determined by the number and types of TOxA cards installed. TOxA cards may be used with all DCD Systems in any combination of the following:

• TOCA: Composite Clock (CC)

• TOTA: DS1 (framed all-ones)

• TOAA: Analog (sine wave)

• TOLA: RS-422/RS-232/RS-423 (TTL)

3.12 For retiming DS1 systems, SCIU cards may be used with the DCD System. In the DCD System, SCIU cards are installed in the TO card slots.

Input and Output Protection

- 3.13 Redundant clock input (CI or ACI) cards and ST cards provide synchronization input protection by giving the TOxA cards a choice of four prioritized timing references from which to automatically select.
- 3.14 Output protection is accomplished by using TOxA cards as Hot Spare (HS) cards. An HS card may be switched into service manually using the pushbuttons mounted above the master shelf or expansion shelf card cage. Both manual and automatic protection switching are under the control of the Matrix Controller Automatic (MCA or MCA-2) card.

Note: There are two versions of the Matrix Controller Automatic card: the MCA and the MCA-2. In this document, information common to the MCA and MCA-2 is referenced as Matrix Controller card. Information unique to a specific card is referenced as the name of the card (MCA or MCA-2).

D. DCD-CIM

- 3.15 The CIM System uses SCIU cards to insert office synchronization on incoming or outgoing DS1 facilities. Each SCIU card retimes and retransmits a bidirectional DS1 signal at DSX-1 levels. The SCIU performs the retiming function on the A direction only. The DS1 B direction is passed through the SCIU.
- **3.16** By imposing office timing on a facility, the SCIU effectively isolates the office from incoming or outgoing transmission impairment, such as jitter and wander. This mitigates the effects of intervening clocks in the timing chain. Additionally, the SCIU al-

lows NEs without the capability of external synchronization to be timed within the BITS concept.

System Components

- **3.17** The CIM System can be configured in one of two ways:
 - a. Standalone (FA, 2 CI [or ACI], 2 ST3E or ST3, and up to 12 SCIU cards per shelf)
 - b. Expansion from an existing ST2 or 400 (FA or AI and up to 12 SCIU cards)
- **3.18** In the standalone configuration, the CIM System becomes the office (BITS) clock.

Note: Using the CIM as a standalone system is not recommended; the CIM does not provide protection switching.

3.19 Up to three expansion shelves can be installed in the CIM standalone configuration, each shelf housing an FA card and up to 12 SCIUs (since SCIU cards are not protection-switchable, SCIU cards can be installed in HS slots #11 and #12).

DS1 Frame Slip Monitoring

- 3.20 When used for DS1 retiming, the SCIU provides frame slip and bit slip (preslip) indications in reference to the office clock. The position of the framing bit of the monitored signal is constantly compared to the position of the framing bit of the reference. A count of bit slips and frame slips is kept and displayed on the front panel lamps of the SCIU.
- **3.21** The SCIU can also be used in a slip-monitor-only mode. In this mode, the SCIU is bridged onto a DS1 via its high impedance interface.

DS1 Bypass Protection

3.22 Both A and B directions have bypass relays on the master shelf backplane (if specified). (If used, the Modular Mounting Panel with SCIU output will have bypass relays in the wire-wrap output kit [p/n 990-40011-10] or an SCIU wire-wrap terminal [p/n 990-40021-10]). In the event of an input reference failure, card failure, power loss, or if the SCIU is removed from the shelf, the DS1 signal is passed through unaffected. If the input is lost, an electronic bypass on the SCIU card is activated to pass the DS1 through.

E. System Expansion

- 3.23 The ST2, 400, and the CIM Systems are designed for modular growth. Up to three expansion shelves may be added to the master shelf, and TOxA or SCIU cards may be added as needed.
- **3.24** The ST2 and 400 master and expansion shelves can be connected to remote expansion systems. A remote expansion system consists of an expansion master shelf and up to three expansion shelves.

Note: The CIM System cannot be used as a remote expansion system.

- 3.25 The remote expansion master shelf is equipped with two clock input cards to accept CC feeds from two different TOCA cards in the DCD master system. (ST cards are optional in the remote expansion master shelf.)
- 3.26 The quantity and type of cards that may be used in each shelf are listed in Table A. All cards are keyed to prevent improper installation. All types of TOxA cards and the SCIU cards can be mixed in the ST2 or 400 shelf. The CIM shelf houses only SCIU or SMU cards.

Table A. Card Quantities (Maximum)

	MAST	TER SHELVES (N	EXPANSION SHELVES (Note 2)			
CARD	DCD-ST2	DCD-ST2 DCD-400		DCD-400	DCD-CIM	
Al Card (090-40014-02)	1					
FA Card (090-40014-01)		1	1	1	1	
CI Card (090-40010-01)	2 (Note 3)	2 (Note 3)	2 (Note 4)			
ACI Card (090-40024-01)	2 (Notes 3 and 5)	2 (Notes 3 and 5)	2 (Note 4)			
ST2E Card (090-40017-02)	2 (Note 6)					
ST2 Card (090-40017-01)	2 (Note 6)					
ST3E Card (090-40019-01)	2 (Note 6)	2 (Note 6)	2 (Notes 1 & 4)			
ST3 Card (090-40013-01)	2 (Note 6)	2 (Note 6)	2 (Notes 1 & 4)			
TOxA Card(s) (Note 7)	4	10		10		
SCIU Card (090-40021-01)	4	10	12	10	12	
Hot Spare TOxA Card (Note 8)	2	2		2		
MCA Card, (Note 8) 090-40015-02	1	1		1		
MCA-2 Card, (Note 8) 090-40015-03	1	1		1		

Notes:

- 1. Although the CIM can be used as a master shelf, it is not recommended. If used as a master shelf, the CIM does not provide protection switching.
- 2. Three expansion shelves are allowed per system. The DCD-400 and CIM shelves may be used as expansion shelves with any master shelf. The ST2 shelf may <u>not</u> be used as an expansion shelf.
- 3. A maximum of two (in any combination of CIs and ACIs) per master shelf.
- 4. CI or ACI cards and ST cards may be installed in the CIM master shelf for a standalone system configuration.
- 5. An ACI card is not required if an LPR-L3 is installed.
- 6. A maximum of two per master shelf. Must be matched sets, e.g., two ST2Es, two ST3Es, or two ST3s.
- 7. Output cards (TOxA) may be any of the following:

TOCA Card 090-40011-02

TOTA Card 090-40012-02

TOAA Card 090-40022-01 or 090-40022-03

TOLA Card 090-40023-01, -02, -03

8. The Matrix Controller card is required, along with one or two HS TOxA cards to implement manual or automatic protection switching.

3.27 Figure 1 shows the ST2 master shelf which houses common equipment (an AI card, CI or ACI cards, and ST2 cards), and up to four TOxA cards. A fully configured ST2 System (four shelves) holds up to 34 TOxA or SCIU cards, or combinations of each. The ST2 shelf cannot be used as an expansion shelf.

3.28 Figure 2 shows the 400 master shelf which houses common equipment (an FA card, CI or ACI cards, and ST3 cards), and up to 10 TOxA cards. This shelf can be used as an expansion shelf for ST2, 400, and CIM master shelves. A fully configured 400 System (4 shelves) holds up to 40 TOxA or SCIU cards, or combinations of both card types.

3.29 Figure 3 shows the CIM master shelf which houses common equipment (FA and CI or ACI cards). For standalone operation, ST3/3E cards may be added with up to 12 SCIU cards. A fully configured CIM System (four shelves) can hold up to 48 SCIU cards. The shelf can also be used as an expansion shelf for the ST2, 400, and CIM master shelves.

Note: Although the CIM can be used as a master shelf (in a standalone configuration), it is not recommended. The CIM does not provide protection switching.

3.30 Figure 4 shows a system configured with the maximum four shelves.

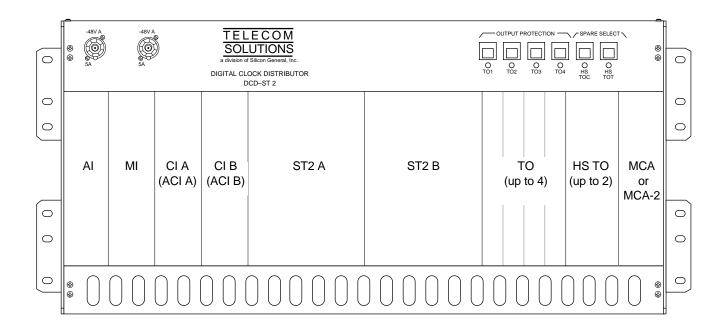


Figure 1. DCD-ST2 Master Shelf

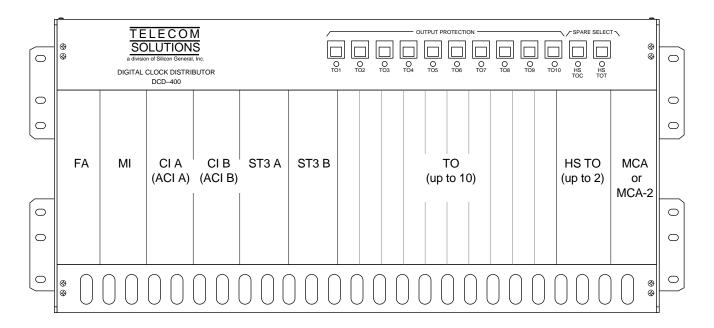
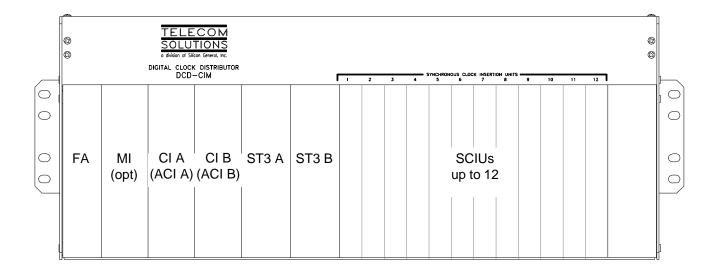
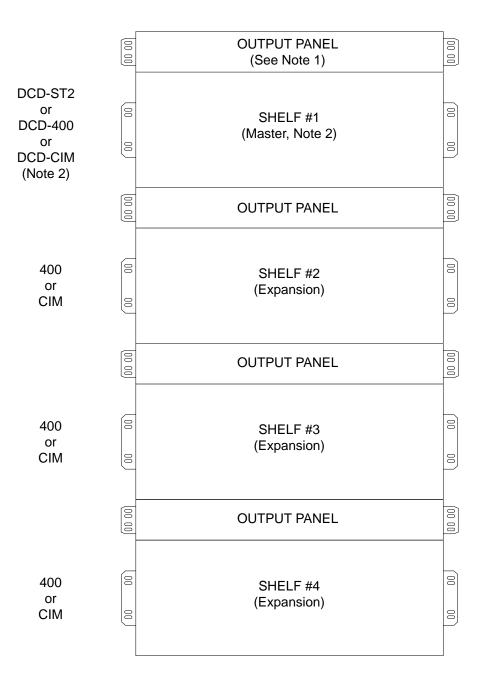


Figure 2. DCD-400 Master Shelf



Note: Although the CIM can be used as a master shelf (in a standalone configuration), it is not recommended. The CIM does not provide protection switching.

Figure 3. DCD-CIM Master Shelf



Notes:

- 1. Output panels may be either Wire-wrap Panels with wire-wrap connections to the network or Modular Mounting Panels that provide a network interface via connectorized Output Kits.
- 2. Although the CIM can be used as a master shelf, it is not recommended. If used as a master shelf, the CIM does not provide protection switching.

Figure 4. DCD System Configuration

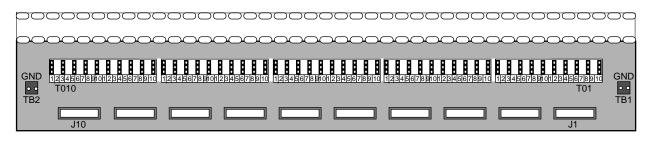
F. Output Panels

- **3.31** An output panel (Modular Mounting or Wirewrap) is mounted above each shelf to provide output connections to the network. The Wire-wrap panel is used if a connectorized network interface is not desired (Figure 5).
- **3.32** A Modular Mounting panel (Figure 20) can be equipped with up to 10 output kits (wire-wrap terminals, DB9 connectors, or BNC connectors) as required

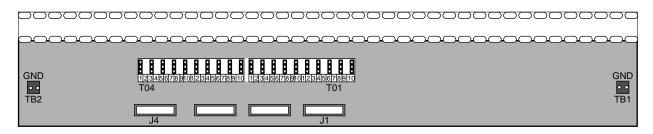
for each TOxA or SCIU card installed. Refer to Table D and Figure 21 for descriptions of the output kits.

3.33 The output from each slot in the shelf is wired to the output panel with ribbon cables so that future expansion only requires adding TOxA or SCIU cards.

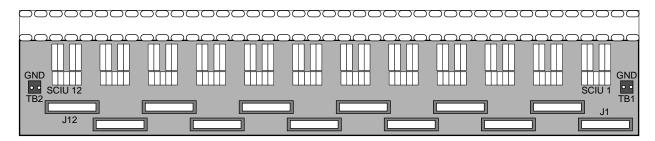
Note: The wire-wrap output panels illustrated in Figure 5B and Figure 5C can be added to the output panel shown in Figure 5A later in an existing arrangement.



A. Wire-wrap Output Panel for DCD-400



B. Wire-wrap Output Panel for DCD-ST2



C. SCIU Wire-wrap Output Panel for DCD-CIM

Figure 5. Wire-wrap Output Panels

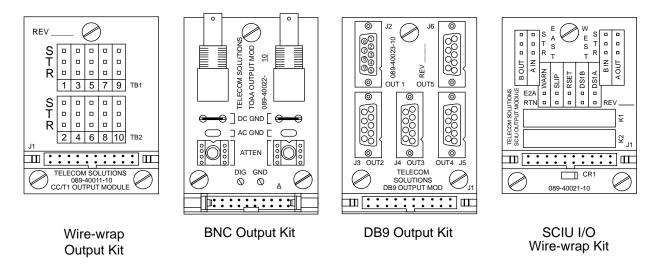


Figure 7. Modular Mounting Panel Output Kits

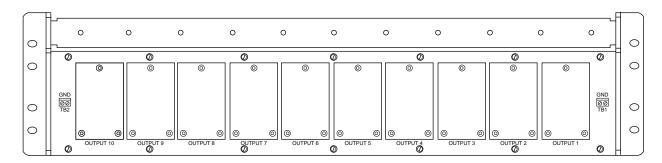


Figure 6. Modular Mounting Panel

Table B. Modular Mounting Panel Output Kits

DESCRIPTION	PART #	USED WITH	COMMENTS
Modular Mounting Panel*	090-40002-31	DCD-400, CIM, and ST2	Accommodates 10 output kits (listed below)
Wire-Wrap Output Kit	990-40011-10	TOCA, TOTA, TOLA Cards	10 wire-wrap output ports
BNC Output Kit	990-40022-10	TOAA Card	2 BNC connectors and attenuator kit
DB9 Output Kit	990-40023-10	TOLA Card (also can be used with TOCA and TOTA)	5 DB9 female connectors for RS-422 and TTL outputs
SCIU I/O Wire-Wrap Kit	990-40021-10	SCIU Card	I/O for one SCIU with wire-wrap pins

^{*} Modular Mounting Panel may be ordered separately for addition of TOAA, TOLA or SCIU cards to the standard DCD assemblies. The DCD shelves can be ordered with the Modular Mounting Panel by specifying p/n 990-40000-08 (400), 990-40000-09 (ST2), or 990-40000-28 (CIM).

G. System Power

- 3.34 The DCD and CIM Systems are powered by two separate -48V dc office battery inputs. Both -48V dc inputs are fused on the shelf, then bused to the rest of the cards in the shelf. Each card contains a dc-to-dc converter to provide its own dc supply voltages. Unfiltered -48V dc can be used to power the systems.
- 3.35 Redundant power sources ensure operation if a single source fails or a single fuse opens. The office BITS clock should be considered as a critical service element.

H. System Diagnostics and Protection Switching

- **3.36** Both the DCD and CIM Systems use sophisticated diagnostics to measure frequency offset, error rates, phase change, and other input and output signal parameters.
- 3.37 If one or more input parameters are not within tolerance, the system switches to an alternate input. If the alternate input is not in tolerance, the system goes into holdover mode, and the internal ST2/ST3E/ST3 becomes the frequency standard for the duration of the outage.
- 3.38 Timing outputs are constantly monitored to ensure a stable signal. In case of an output port failure on a TOxA card, the system supports switching to an HS card. A TOxA card failure also is supported by HS switching.
- 3.39 Optional HS output protection is implemented by installing one or two TOxA cards in the HS slots. These can be activated manually using the pushbuttons on the master front panel or automatically by the MCA (or MCA-2) card.

Note: No output protection is available for SCIU or SMU cards in any shelf. However, the

SCIU card includes DS1 bypass capabilities to pass the DS1 through unaffected in the event of a system failure.

3.40 The modular design of both the DCD and CIM Systems simplifies system expansion, troubleshooting, and repair. Front panel lamps provide clock driver status, input signal status, error alarms, and failure status.

4. APPLICATIONS

A. DCD Applications

- 4.01 The BITS concept advocates the establishment of a single master timing supply for each administrative building. A BITS contains the BITS clock: the lowest-numbered stratum, highest-accuracy clock within a building that is directly synchronized by the interbuilding synchronization network. The BITS also distributes all timing required by other clocks within that building.
- 4.02 A BITS may receive its reference signal(s) from either a Stratum-1 clock, an Interexchange Carrier timing interface (reference connection), or a BITS in another building. The reference signals must be generated from a clock of equal or greater accuracy (lower numbered stratum) than the BITS that uses the reference. Under normal operating conditions, all clock signals are traceable to a Stratum-1 primary reference.
- 4.03 The DCD provides system-wide synchronization via CC, DS1, analog or TTL/RS-422/RS-232 timing signals. The DCD regenerates a clocking signal from its input reference and buffers phase (byte or frame) variations. Phase variation problems are alleviated by introducing an adjustable phase delay so that signals can be supplied to DS0-rate interconnecting equipment located up to 3000 feet from the DCD source.

4.04 The DS1 timing signal is a non-service-carrying signal which uses a framed, all-ones, bipolar return-to-zero (RTZ), 50-percent duty cycle line format. The analog output can be used for digital switches, radio, and FDM carrier switches. The TTL/RS-422/RS-232 signals are used for data equipment, PBX, small remote switching modules, and T1 multiplexers.

- 4.05 Figure 22 illustrates typical DCD applications. The DCD can interface to additional timing signal generators (TSG) and to existing equipment that requires network timing such as digital switches, digital cross-connects, channel banks, SONET terminals, test systems, and digital data system (DDS) equipment.
- **4.06** An additional, although rare, application, may be a digital island network with no internetwork connectivity which may be timed with a DCD equipped with stratum clocks in freerun mode.

B. SCIU Applications

- 4.07 The SCIU cards in a CIM shelf system provide a method of distributing the BITS clock to network equipment that does not allow for external timing inputs, such as some digital switches. In this case, without the SCIU, two DS1 lines would ordinarily be "nailed up" to provide timing to the switch. This method reduces the productivity of the switch. By using the SCIU cards on the two DS1 lines (Figure 23A), the switch can now process traffic on the DS1 lines while the SCIU provides traceable and backup timing. Preferably, the SCIUs in this application will be timed by a Stratum-2 BITS clock such as the DCD-ST2.
- 4.08 The DS1 signal at the output of the SCIU towards the switch is a retimed version of the incoming trunk. Coding and framing are left intact to

allow the switch to continue to monitor end-to-end transmission performance.

- 4.09 Often when a digital switch is transmitting synchronization downstream to another office or independent telco, the switch's output has a certain amount of wander, due in part to the switch "breathing" and its processor routines. The receiving switch must be able to recover the frequency component and apply it to its clock. The SCIU can be deployed at the output of the switch (Figure 23B) to isolate the switch timing from the office timing and provide a stable downstream clock without jitter or wander. This mitigates the effects of intervening clocks.
- 4.10 Figure 23C illustrates a typical SCIU Hi-Cap application. To provide external timing, a through DCS circuit needs to be allocated for timing purposes, effectively removing two expensive DCS ports from revenue service. Because the SCIU can inject network synchronization on any DS1 facility, it provides a solution to the problem which does not deplete traffic carrying circuits.
- **4.11** While the SCIU effectively isolates the office from incoming or external network timing, it also eliminates the problems associated with multiple office clocks and network timing chains developing phase walk and frequency offsets.
- **4.12** Two SCIUs can be connected to send the DS1 signal in two directions (Figure 23D). The DS1 output signals of both SCIUs (towards the switch) are reclocked versions of the incoming signals.
- **4.13** When used as a slip monitor (Figure 23E), the SCIU provides a measure of incoming versus office clock timing which can be used to monitor the integrity of the synchronization network or timing back from a downstream office.

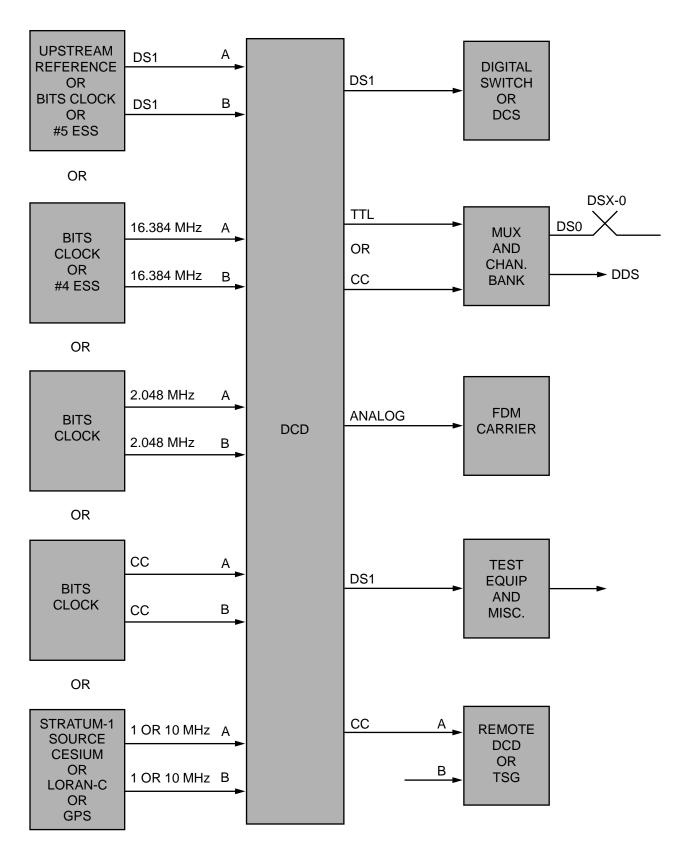


Figure 8. Typical DCD Applications

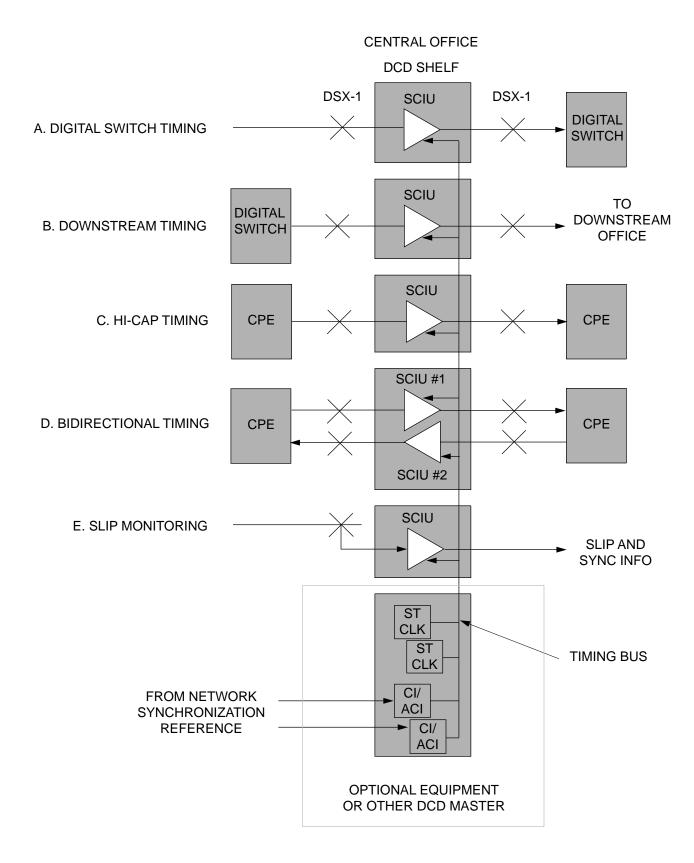


Figure 9. SCIU Applications

5. SPECIFICATIONS

5.01 The ST2, 400, and CIM System specifications are listed in Table E. Specifications for the individual cards are listed in Table F.

Table C. System Specifications

ITEM	DCD-ST2	DCD-400	DCD-CIM					
GENERAL								
Input Reference	DS1 (D4, ESF, B8ZS), Type II (Stratum-2 or better per ANSI T1-101)	Dual DS1 (D4, ESF, B8ZS), dual CC, or DCD expansion bus	Dual DS1 (D4, ESF, B8ZS), dual CC, or DCD expansion bus					
TOxA Cards Per Shelf (max.)	4 (master) 10 (expansion)	10 (master) 10 (expansion)						
TOxA Cards Per System (max.)	34	40						
SCIU Cards Per Shelf (max.)	4 (master)	10	12					
SCIU Cards Per System (max.)	34	40	48					
Output Connectors	Wire-wrap terminals or Modular Mounting Panel with Output Kits	Wire-wrap terminals or Modular Mounting Panel with Output Kits	Modular Mounting Panel with SCIU wire- wrap Output Kit					
Internal Clock	Stratum-2, rubidium atomic oscillator (Stra- tum-3 or enhanced Stra- tum-3 crystal oscillator)	Stratum-3 or enhanced Stratum-3 crystal oscil- lator	(Optional Stratum-3 or enhanced Stratum-3 crystal oscillator)					
Warm-up Time	60 minutes	5 min./30 min. ST3E	5 minutes					
	POWE	ER .						
Voltage	-48V dc ±10%	-48V dc ±10%	-48V dc ±10%					
Current, Master Shelf (Note 1)	1.5A (Note 2)	1.3A	1.5A					
Current, Expansion Shelf	1.3A	1.3A	1.3A					
Recommended Fusing for Master Shelf	8A	ЗА	3A					
Recommended Fusing for Expansion Shelf	3A	ЗА	3A					

Notes:

- 1. Current specifications for fully loaded shelves.
- 2. For the first 30 minutes, the ST2 needs 4A.

Table C. System Specifications (Contd)

ITEM	DCD-ST2	DCD-400	DCD-CIM						
PHYSICAL									
Master Shelf Dimensions (W x D x H) (w/output panel)	23" x 14" x 12"	23" x 12.25" x 12"	23" x 12.25" x 12"						
Expansion Shelf	23" x 12.25" x 12"	23" x 12.25" x 12"	23" x 12.25" x 12"						
Weight (fully loaded)	25 pounds (approx)	25 pounds (approx)	25 pounds (approx)						
Operating Temperature	0 - 45°C	0 - 50°C	0 - 50°C						
Humidity	0 - 95%, noncondensing	0 - 95%, noncondensing	0 - 95%, noncondensing						
	ALARM AND STAT	US OUTPUTS							
Relay Contact Ratings	2A, resistive load	2A, resistive load	A, resistive load						
Audible and Visual Alarms (major and minor)	Normally open and nor- mally closed contacts	Normally open and nor- mally closed contacts	Normally open and nor- mally closed contacts						
Alarm Status Indication (major and minor)	Normally open contacts	Normally open contacts	Normally open contacts						
Status Leads (5-7 Ω ground on return lead)	All ST2 SI, clock loss and port alarm are open collector Naps, 120V, 50 mA nominal, 500 mA maximum	Open collector PNP, 120V, 50 mA nominal, 500 mA maximum	Open collector PNP, 120V, 50 mA nominal, 500 mA maximum						

Table D. Card Specifications

ITEM	SPECIFICATION					
CI CARD						
DS1 Input Signal Monitor	Loss of signal (LOS) or AIS, OOF, and COFA					
Input Error Threshold	Error rate of 10 ⁻⁶ (based on BPV)					
Framing Protocols	D4 /ESF					
Input Signal Level, Terminated	1.0 to 3.5 V base-to-peak, -10 dB up to 655 ft. from DSX					
Input Signal Level, Bridged	0.1 to 0.35 V base-to-peak, up to 655 ft. from DSX					
Input Signal Impedance	Bridging or terminated, 100 Ω resistive					
Input Signal Jitter Tolerance	10-unit intervals, peak-to-peak, 0-310 Hz; 0.3-unit intervals, 10 kHz to 50 kHz (per Pub TA-TSY-000378)					
Composite Clock Input Format	64 kb/s all-ones, RTZ, 62.5% duty cycle, up to 1500 ft. from source					
Composite Clock Input Level	1.5 to 4.0 V base-to-peak					
Composite Clock Input Impedance	135 Ω resistive					
Dimensions (HxWxD)	6.0 in. x 1.625 in. x 9.625 in. + 0.25 in. (for latch)					
	ACI CARD					
Input Signal Type	Analog 2.048 MHz (CCITT G.703, Table 10), 1.0, 5.0, and 10.0 MHz sine wave					
Input Signal Level	0.3 V to 1.5 V rms					
Input Impedance	75 Ω ±5%					
Input Frequency	Switch-selectable: 10 MHz sine wave, 5.0 MHz sine wave, 2.048 MHz sine wave, 1 MHz sine wave					
Clock Holdover	2 seconds with zero phase shift					
Transfer Time	2 seconds					
Dimensions (HxWxD)	6.0 in. x 1.625 in. x 9.625 in. + 0.25 in. (for latch)					
	ST2E CARD					
Accuracy	±1 x 10 ⁻⁹					
Holdover Stability 0 to 24 hrs at 25°C 0 to 24 hrs from 0 to 45°C 30 days	±2 x 10 ⁻¹¹ ±5 x 10 ⁻¹¹ ±1 x 10 ⁻¹⁰					
Input Tolerance	±1.6 x 10 ⁻⁸					
Pull-in Range	±1.6 x 10 ⁻⁸					
Lock Range	±1 x 10 ⁻⁹					
Convergence Time	≤1 hour					

Table D. Card Specifications (Contd)

ITEM	SPECIFICATION
Warm-up Time	≤30 minutes
Operating Temperature	0°C to +45°C
Storage Temperature	-40°C to +70°C
Dimensions (HxWxD)	152.4 mm x 38.1 mm x 244.34 mm + 6.35 mm (for latch) (occupies 2 slots in DCD shelf)
	ST2 CARD
Source	Rubidium atomic oscillator
Clock Holdover Stability: 0-24 hours, 0-25°C 0-24 hours, 0-45°C 30 days	±4.0 x 10 ⁻¹¹ ±1.0 x 10 ⁻¹⁰ ±1.5 x 10 ⁻¹⁰
Accuracy (20 years)	1.0 x 10 ⁻⁹
Input Tolerance	±1.6 x 10 ⁻⁸
Pull-in Range	±1.6 x 10 ⁻⁸
Lock Range	±2.0 x 10 ⁻⁹
Convergence Time	≤2 hours
Warm-up Time	1 hour
Operating Temperature	0-45°C
Dimensions (HxWxD)	6.0 in. x 4.0 in. x 9.625 in. + 0.25 in. (for latch)
	ST3E CARD
Source	Oven-controlled crystal oscillator
Accuracy (20 years)	1.0 x 10 ⁻⁶
Clock Holdover Stability: 0-24 hours, 25°C 0-24 hours, 0-50°C 30 days	±3.0 x 10 ⁻¹⁰ ±1.0 x 10 ⁻⁸ ±1.0 x 10 ⁻⁸
Input Tolerance (switch-selectable)	±5.0 x 10 ⁻⁶ ±2.0 x 10 ⁻⁶
Pull-in Range (switch-selectable)	±5.0 x 10 ⁻⁶ ±2.0 x 10 ⁻⁶
Lock Range	±1.0 x 10 ⁻⁷
Convergence Time	≤1 hour
Warm-up Time	30 minutes
Operating Temperature	0-50°C
Dimensions (HxWxD)	6.0 in. x 1.625 in. x 9.625 in. + 0.25 in. (for latch)

Table D. Card Specifications (Contd)

ITEM	SPECIFICATION						
Input Tolerance (switch-selectable)	±5.0 x 10 ⁻⁶ ±2.0 x 10 ⁻⁶						
ST3 CARD							
Source	Temperature-controlled crystal oscillator						
Clock Holdover Stability: 0-24 hours, 25°C 0-24 hours, 0-50°C 30 days	±3.0 x 10 ⁻⁹ ±1.0 x 10 ⁻⁷ ±1.0 x 10 ⁻⁷						
Accuracy (20 years)	1.0 x 10 ⁻⁵						
Input Tolerance	±15.0 x 10 ⁻⁶						
Pull-in Range	±15.0 x 10 ⁻⁶						
Lock Range	±15.0 x 10 ⁻⁶						
Convergence Time	≤30 sec.						
Warm-up Time	Not Applicable						
Operating Temperature	0-50°C						
Dimensions (HxWxD)	6.0 in. x 1.625 in. x 9.625 in. + 0.25 in. (for latch)						
	TOCA CARD						
Output Type	Composite clock (digital 64/8 kb/s)						
Waveform	2.7 to 5.5 V peak, 3 V nominal; bipolar RTZ; all-ones with BPV every eighth pulse						
Wave Shape	Rectangular, rise time <500 ns, pulse width 9.8 μ s ±5%, pulse interval 15.6 μ s ±5%						
Impedance	133 Ω , ±5%; resistive; can drive up to 6 downstream devices						
Duty Cycle	62.5%						
Drive Capability	0 to 3,000 ft of twisted-pair, 22 AWG cable in the following lengths: 0-1500, 1501-2000, 2001-2500, and 2501-3000 ft						
Number of Ports	10						
Dimensions (HxWxD)	6.0 in. x 0.75 in. x 9.625 in. + 0.25 in. (for latch)						
	TOTA CARD						
Output Type	DS1						
Waveform	2.4 to 3.6 V peak, 3.5 V nominal; bipolar return to zero, all-ones; ESF or D4 format, per Pub 43801						
Wave Shape	Rectangular, rise time <100 ns, pulse width 325 ns ± 30 ns, pulse interval 648 ns ± 64 ns, per CB-119						
Impedance	100 Ω ±5%; resistive; can drive up to 2 downstream devices						

Table D. Card Specifications (Contd)

ITEM		SPECIFICATION							
Overshoot	≤10% o	≤10% of peak-to-base amplitude							
Duty Cycle	50%	50%							
Output Drive Capability	0 to 655	0 to 655 ft of twisted-pair, 22 AWG ABAM cable							
Number of Ports	10								
Dimensions (HxWxD)	6.0 in. x	0.75 in. x	9.62	25 in. + 0.25 in	. (for latch)				
		TOL	A -0	1 CARD					
Output Type	Logic le	vel; RS-42	2 or	RS-423 (TTL))				
Wave Amplitude				(balanced) in alanced) into 4					
Wave Shape	Square	wave							
Impedance	100 Ω r	esistive, ba	aland	ced; 450 Ω res	sistive, unbalan	iced			
Data Rates: RS-422 Wire-wrap Panel Frequency groups 0–3 selectable by switch on card	Group 0 1 2 3	Out 1 4 kb/s 256 kb/s 384 kb/s 1.544 Mb		Out 3 8 kb/s 512 kb/s 768 kb/s 1.544 Mb/s	Out 5 64 kb/s 2.048 Mb/s 1.536 Mb/s 1.544 Mb/s	1.544 Mb/s 1.544 Mb/s	Out 9 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s		
Data Rates: RS-423 Wire-wrap Panel Frequency groups 0–3 selectable by switch on card	Group 0 1 2 3	Out 1 & 2 4 kb/s 256 kb/s 384 kb/s 1.544 Mb		Out 3 & 4 8 kb/s 512 kb/s 768 kb/s 1.544 Mb/s	Out 5 & 6 64 kb/s 2.048 Mb/s 1.536 Mb/s 1.544 Mb/s				
Data Rates: RS-422 DB9 Connector Frequency groups 0–3 selectable by switch on card	Group 0 1 2 3	Out 1 1.544 Mb 1.544 Mb 1.544 Mb 1.544 Mb	o/s o/s	Out 2 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s	Out 3 64 kb/s 2.048 Mb/s 1.536 Mb/s 1.544 Mb/s	Out 4 8 kb/s 512 kb/s 768 kb/s 1.544 Mb/s	Out 5 4 kb/s 256 kb/s 384 kb/s 1.544 Mb/s		
Cable Lengths RS-422 24 AWG Twisted Pair	Data Rate 4, 8, 64 kb/s 256 kb/s 384 kb/s 512 kb/s		3275 ft 7 1300 ft 1 825 ft 1		Data RateDistance768 kb/s400 ft1.536 Mb/s225 ft1.544 Mb/s225 ft2.048 Mb/s150 ft		oft oft oft		
Cable Lengths RS-423 (TTL) 24 AWG Twisted Pair	Data Rate Distance 4 kb/s 825 ft 8 kb/s 325 ft 64 kb/s 50 ft ≥100 kb/s Not recommended			ed					
Number of Ports	5 RS-422 or 10 RS-423 (TTL)								
Dimensions (HxWxD)	6.0 in. x	0.75 in. x	9.62	25 in. + 0.25 in	. (for latch)				

Table D. Card Specifications (Contd)

ITEM	SPECIFICATION						
	TOLA -02 CARD						
Output Type	Logic le	Logic level; RS-422 or RS-423 (TTL)					
Wave Amplitude			2 (balanced) in alanced) into 4				
Wave Shape	Square	wave					
Impedance	100 Ω re	esistive, balar	nced; 450 Ω res	sistive, unbalar	nced		
Data Rates (four frequency groups) - From wire-wrap panel	Group 0 1 2 3	0 8 kb/s 8 kb/s 8 kb/s 8 kb/s 8 kb/s 1 256 kb/s 512 kb/s 2.048 Mb/s 1.544 Mb/s 1.544 Nb/s Nb/s Nb/s Nb/s Nb/s Nb/s Nb/s Nb/s					
Data Rates (four frequency groups) - From DB9 connector	Group 0 1 2 3	Out 1 8 kb/s 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s		Out 3 8 kb/s 2.048 Mb/s 1.536 Mb/s 1.544 Mb/s	768 kb/s	Out 5 8 kb/s 256 kb/s 384 kb/s 1.544 Mb/s	
RS-422 24 AWG Twisted Pair (Maximum Distance)	Data Rate Distance 8 kb/s 3275 ft 256 kb/s 1300 ft 384 kb/s 825 ft 512 kb/s 650 ft			Data Rate Distance 768 kb/s 400 ft 1.536 Mb/s 225 ft 1.544 Mb/s 225 ft 2.048 Mb/s 150 ft			
RS-423 (TTL) 24 AWG Twisted Pair (Maximum Dis- tance)	Data Ra 8 kb/s ≥100 kb	32	istance 25 ft ot recommende	ed			
Number of Ports	5 RS-42	22 or 10 RS-4	23 (TTL)				
Dimensions (HxWxD)	6.0 in. x	0.75 in. x 9.6	25 in. + 0.25 ir	n. (for latch)			
		TOLA -(03 CARD				
Output Type	RS-232						
Wave Amplitude	>+3 V from GND and >-3 V from GND for RS-232 into 3 to 7 k Ω						
Wave Shape	Square wave						
Impedance	100 Ω re	esistive, balar	nced; 450 Ω res	sistive, unbalar	nced		
Data Rates (four frequency groups) - From wire-wrap panel	Group 0 1 2 3	Out 1 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 2 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 3 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 4 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 5 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	

Table D. Card Specifications (Contd)

ITEM			SPE	CIFICATION				
Data Rates (four frequency groups) -From DB9 connector	Group 0 1 2 3	Out 1 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 2 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 3 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 4 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 5 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s		
RS-232 24 AWG Twisted Pair (Maximum Distance)	4.8 kb/s 9.6 kb/s 19.2 kb	Data Rate Distance 4.8 kb/s 50 ft 9.6 kb/s 50 ft 19.2 kb/s 50 ft 56 kb/s Not recommended						
Number of Ports	5							
Dimensions (HxWxD)	6.0 in. >	0.75 in. x 9	9.625 in. + 0.25	in. (for latch)				
		TOLA	A -04 CARD					
Output Type	Logic le	vel; RS-422	2 (RS-423 (TTL)	not recommer	nded)			
Wave Amplitude	2 to 6 V	pp for RS-	422 (balanced) i	into 100 Ω				
Wave Shape	Square wave							
Impedance	100 Ω r	esistive, ba	lanced; 450 Ω re	esistive, unbala	anced			
Data Rates	All data	rates are 2	.048 Mb/s					
Cable Lengths (max. in meters; RS-422) 24 AWG Twisted Pair (Maxi- mum Distance)	<u>Data Ra</u> 2.048 N		<u>Distance</u> 160 ft					
Number of Ports	5 RS-42	22 or 10 RS	-423 (TTL)					
Dimensions (HxWxD)	6.0 in. >	0.75 in. x 9	9.625 in. + 0.25	in. (for latch)				
		TOLA	A -05 CARD					
Output Type	Logic le	vel; RS-422	2 or RS-423 (TT	L)				
Wave Amplitude	2 to 6 V pp for RS-422 (balanced) into 100 Ω >3 V for RS-423 (unbalanced) into 450 Ω							
Wave Shape	Square	wave						
Impedance	100 Ω r	esistive, ba	lanced; 450 Ω re	esistive, unbala	anced			
Data Rates (four frequency groups) - From wire-wrap panel	Group 0 1 2 3	Out 1 1.544 Mb 1.544 Mb 1.544 Mb 1.544 Mb	/s 64 kb/s /s 64 kb/s	Out 3 128 kb/s 128 kb/s 128 kb/s 128 kb/s	Out 4 192 kb/s 192 kb/s 192 kb/s 192 kb/s	Out 5 1.024 Mb/s 1.024 Mb/s 1.024 Mb/s 1.024 Mb/s		

Table D. Card Specifications (Contd)

ITEM	SPECIFICATION							
Data Rates (four frequency groups) - From DB9 connector	Group 0 1 2 3	Out 1 1.024 Mb 1.024 Mb 1.024 Mb 1.024 Mb	o/s 192 o/s 192	kb/s kb/s kb/s	Out 3 128 kb/s 128 kb/s 128 kb/s 128 kb/s	Out 4 64 kb/s 64 kb/s 64 kb/s 64 kb/s	Out 5 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s 1.544 Mb/s	
RS-422 24 AWG Twisted Pair (Maximum Distance)	Data Rate 64 kb/s 128 kb/s 192 kb/s		<u>Distance</u> 3275 ft 2600 ft 1650 ft		<u>Data Rate</u> 1.024 Mb/s 1.544 Mb/s		Distance 300 ft 225 ft	
RS-423 (TTL) 24 AWG Twisted Pair (Maximum Distance)	Data Rate 64 kb/s ≥100 kb/s		Distance 50 ft Not reco		ed			
Number of Ports	5 RS-422 or 10 RS-423 (TTL)							
Dimensions (HxWxD)	6.0 in. x	0.75 in. x	9.625 in	+ 0.25 ir	n. (for latch)			
		TOL	A -06 CAF	RD.				
Output Type	Logic level; RS-422 or RS-423 (TTL)							
Wave Amplitude	2 to 6 V pp for RS-422 (balanced) into 100 Ω >3 V for RS-423 (unbalanced) into 450 Ω							
Wave Shape	Square wave							
Impedance	100 Ω resistive, balanced; 450 Ω resistive, unbalanced							
Data Rates (four frequency groups) - From both wire-wrap panel and DB9 connector	Group 0 1 2 3	Out 1 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out : 4.8 k 9.6 k 19.2 56 k	b/s b/s kb/s	Out 3 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 4 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	Out 5 4.8 kb/s 9.6 kb/s 19.2 kb/s 56 kb/s	
RS-422 24 AWG Twisted Pair (Maximum Distance)	Data Ra 4.8 thru	ate 56 kb/s	Distance 3275 ft					
RS-423 (TTL) 24 AWG Twisted Pair (Maximum Dis- tance)	Data Ra 4.8 kb/s 9.6 kb/s 19.2 kb/ 56 kb/s	;	Distance 825 ft 325 ft 150 ft 50 ft					
Number of Ports	5 RS-422 or 10 RS-423 (TTL)							
Dimensions (HxWxD)	6.0 in. x 0.75 in. x 9.625 in. + 0.25 in. (for latch)							
TOLA -07 CARD								
Output Type	Logic level; RS-422 (RS-423 (TTL) not recommended)							
Wave Amplitude	2 to 6 V pp for RS-422 (balanced) into 100 Ω							
Wave Shape	Square wave							

Table D. Card Specifications (Contd)

ITEM	SPECIFICATION						
Impedance	100 Ω resistive, balanced; 450 Ω resistive, unbalanced						
Data Rates (four frequency groups) - From both wire-wrap panel and DB9 connector	Group 0 1 2 3	Out 1 2.048 Mb/s 1.024 Mb/s 512 kb/s 256 kb/s		b/s 2. b/s 1.	ut 3 048 Mb/s 024 Mb/s 12 kb/s 56 kb/s	Out 4 2.048 Mb/s 1.024 Mb/s 512 kb/s 256 kb/s	
RS-422 24 AWG Twisted Pair (Maximum Distance)	Data Rate 256 kb/s 512 kb/s		Distance 1300 ft 650 ft		Data Rate Distant 1.024 Mb/s 300 ft 2.048 Mb/s 150 ft		ft
Number of Ports	5 RS-42	5 RS-422 or 10 RS-423 (TTL)					
Dimensions (HxWxD)	6.0 in. x 0.75 in. x 9.625 in. + 0.25 in. (for latch)						
TOAA CARD (-01, -02, -03, and -05)							
Output Type	Analog	Analog					
Waveform	1 V rms						
Wave Shape	Sine wave						
Impedance	75 ohms $\pm 5\%$, resistive, unbalanced for -01, -03, and -05 50 ohms $\pm 5\%$, resistive, unbalanced for -02						
Output Frequency	Switch-selectable (-01, -02): 2.048 MHz, 1.0 MHz, 512 kHz, or 64 kHz (-03): 2.048 MHz, 1.0 MHz, 512 kHz, or 8 kHz (-05): 5 MHz						
Level Attenuators	0, 3, 30, 60 dB						
Number of Ports	2						
Dimensions (HxWxD)	6.0 in. x 0.75 in. x 9.625 in. + 0.25 in. (for latch)						
		SCI	U CARD				
Input	Bidirectional DS1						
DS1 Input, A and B	Message DS1 1.544 Mb/s (framed or unframed)						
Input Monitor	LOS or AIS, OOF						
Input Error Threshold	2 out of 4 OOF, 32 consecutive zeroes						
Framing Protocols	D4, ESF; with or without B8ZS or AMI						
Input Signal Level, Terminated	DSX-1, 1.5 to 4.5 V base-to-peak, up to 655 ft from DSX-1						
Input Signal Level, Bridging	0.15 to 0.45 V base-to-peak, up to 655 ft from DSX-1						
Input Signal Level, Impedance	Bridging, or terminated in 100 Ω						
Input Signal Level, Jitter Tolerance	10 UI p-p, 0.31-10 kHz; 0.3 UI p-p, 10-100 kHz (per T1.102)						
DS1 Output, Levels A and B	3 V base-to-peak nominal before line build-out pre-emphasis (per ANSI T1.102-1988)						

Table D. Card Specifications (Contd)

ITEM	SPECIFICATION			
DS1 Output Impedance	100 Ω			
Residual Jitter Output, DS1 A	0.025 UI with Stratum-2 source; 0.1 UI with ST3E source, 0.05 to 100 kHz			
DS1 A Buffer Size	±192 bits, ± DS1 frame			
DS1 A Buffer Hysteresis	64 bits, approximately 40 μs			
DS1 A Through Delay	Nominal 125 μs; 250 μs maximum			
DS1 B Through Delay	Nominal 2.6 μs; 5.2 μs maximum			
Dimensions (HxWxD)	6.0 in. x 0.75 in. x 9.625 in. + 0.25 in. (for latch)			